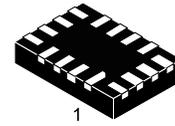


Fully Configurable 8-Bit I²C-Controlled GPIO Expander

FXL6408



UQFN16
CASE 523BF

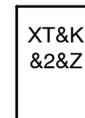
Description

The FXL6408 is an 8-bit I²C-controlled GPIO expander. When configured in Input Mode, the FXL6408 monitors the input ports for data transitions and signals the baseband by asserting the $\overline{\text{INT}}$ pin. The input default values can be programmed independently, allowing customized input detection. All inputs can be configured with pull-up or pull-down resistors to pre-bias the inputs in open-drain or non-driven applications. When configured in Output Mode, the GPIO pins are capable of delivering 6 mA output drive according to the I²C register set. The FXL6408 is designed to allow voltage translation from levels as low as 1.65 V and up to 4.0 V. The FXL6408 features an active LOW RESET input as well as Power-On Reset (POR) circuit and I²C software reset options.

Features

- 4X Expansion of Connected Processor I/O Ports
- Fully Integrated I²C Slave
- 8 Independently Configurable I/O Ports
- Low-Power Quiescent Current: 1.5 μA
- Voltage Translation Capable from 1.65 V I²C Port Up to 4.0 V GPIO Pins
- Selectable Device Address
- 6 mA Output Drive
- Interrupt Pin to Alert Processor of Status Changes

MARKING DIAGRAM



XT	= FXL6408 Device Code
&K	= Lot Trace Code
&2	= Two Digit Date Code
&Z	= Assembly Plant Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 12 of this data sheet.

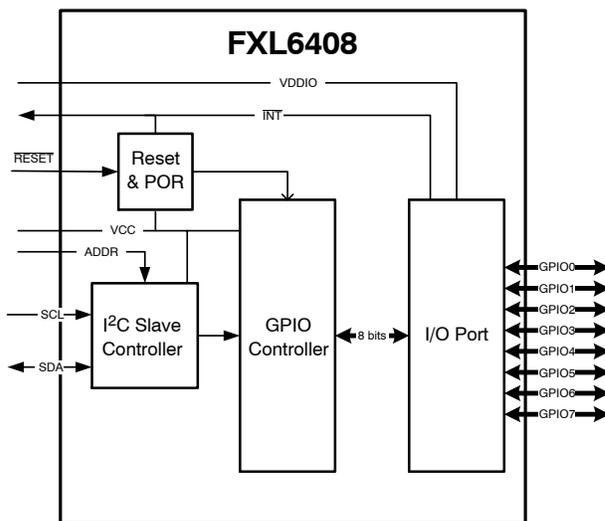


Figure 1. FXL6408 Block Diagram

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PIN CONFIGURATION

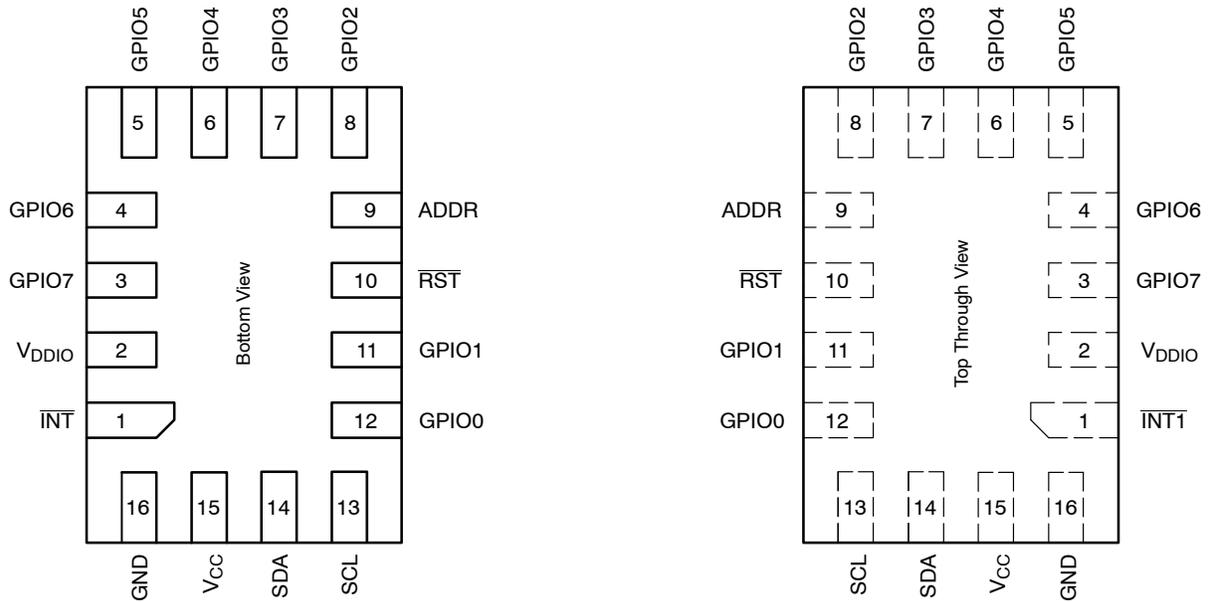


Figure 2. FXL6408 Pin Assignment (Top Through and Bottom Views)

Table 1. PIN DESCRIPTIONS

Pin No.	Pin Name	Description
1	INT	Interrupt Output, Open-Drain, Active LOW; Requires an External Pull-Up Resistor to V_{CC}
2	V_{DDIO}	Voltage Reference for I/O-Side Voltage Translation (if I/O Translation is not needed, tie V_{DDIO} to the V_{CC} supply)
3	GPIO7	General-Purpose Programmable I/O
4	GPIO6	General-Purpose Programmable I/O
5	GPIO5	General-Purpose Programmable I/O
6	GPIO4	General-Purpose Programmable I/O
7	GPIO3	General-Purpose Programmable I/O
8	GPIO2	General-Purpose Programmable I/O
9	ADDR	Address Input, GND or V_{CC}
10	\overline{RST}	Reset Input, Active LOW, Requires a pull-Up Resistor to V_{CC}
11	GPIO1	General-Purpose Programmable I/O
12	GPIO0	General-Purpose Programmable I/O
13	SCL	I ² C Serial Bus; Requires a Pull-Up Resistor to V_{CC}
14	SDA	I ² C Serial Data; Requires a Pull-Up Resistor to V_{CC}
15	VCC	Supply Voltage
16	GND	Ground

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Table 2. ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Condition	Min	Max	Unit
V_{CC}, V_{DDIO}	Supply Voltages		-0.5	4.6	V
V_{IN}	DC Input Voltage		-0.5	4.0	V
V_{OUT}	Output Voltage (Note 1)		-0.5	4.0	V
I_{IK}	DC Input Diode Current	$V_{IN} < 0\text{ V}$		-50	mA
I_{OK}	DC Output Diode Current	$V_{OUT} < 0\text{ V}$		-50	mA
I_{OL}	DC Output Sink Current			+50	mA
I_{CC}	DC V_{CC} or Ground Current per Supply Pin			± 100	mA
T_{STG}	Storage Temperature Range		-65	+150	$^{\circ}\text{C}$
T_J	Junction Temperature under Bias			+150	$^{\circ}\text{C}$
T_L	Junction Lead Temperature, Soldering 10 seconds			+260	$^{\circ}\text{C}$
θ_{JA}	Thermal Resistance, Junction-to-Ambient			115	$^{\circ}\text{C}/\text{W}$
ESD	Electrostatic Discharge Capability	Human Body Model, JESD22-A114		4	kV
		Charged Device Model, JESD22-C101		2	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. All output current absolute maximum ratings must be observed.

Table 3. RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Condition	Min	Max	Unit
V_{CC}	Supply Voltage Operating		1.65	3.60	V
V_{DDIO}	I/O Side Reference Voltage		1.65	4.00	V
V_{IN}	Input Voltage on I/O Pins		0	4.00	V
V_{OUT}	Output Voltage		0	V_{DDIO}	V
T_A	Operating Temperature		-40	+85	$^{\circ}\text{C}$
t_r, t_f	Input Rise and Fall Times to I/O Pins when Configured as Inputs	V_{DDIO} at 1.8 V, 2.5 V $\pm 0.2\text{ V}$	0	200	ns/V
		V_{DDIO} at 3.6 V $\pm 0.3\text{ V}$	0	100	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

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Table 4. DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Condition	V _{CC} (V)	T _A = 25°C			T _A = -40 to 85°C		Unit
				Min	Typ	Max	Min	Max	
				RST, ADDR, SDA, SCL, INT Pins					
V _{POR}	Power-On Reset Voltage	V _{DDIO} = 0 to 4.0 V				1.25		1.25	V
I _{IN}	Input Leakage Current	0 ≤ V _{IN} ≤ V _{CC}	0 to 3.6			±1		±10	μA
I _{OFF}	Power-Off Leakage Current	V _{IN} or V _{OUT} = 3.6 V	0			1		10	μA
I _{CC}	Standby Mode (SCL in Static Condition)	V _{IN} = V _{CC} or GND	1.8 to 3.6			1.2		1.5	μA
	Active Mode (SCL Active) (Note 2)					300		300	
GPIO Pins									
V_{DDIO} (V)									
V _{IH}	HIGH Level Input Voltage		1.65 to 1.95	0.65 V _{DDIO}			0.65 V _{DDIO}		V
			2.30 to 4.00	0.70 V _{DDIO}			0.70 V _{DDIO}		
V _{IL}	LOW Level Input Voltage		1.65 to 1.95	-0.3		0.35 V _{DDIO}	-0.3	0.35 V _{DDIO}	V
			2.30 to 4.00	-0.3		0.30 V _{DDIO}	-0.3	0.30 V _{DDIO}	
V _{OH}	HIGH Level Output Voltage	V _{IN} = V _{IH} , I _{OH} = 100 μA	1.8	V _{DDIO} -0.2			V _{DDIO} -0.2		V
			3.6	V _{DDIO} -0.2			V _{DDIO} -0.2		V
			4.0	V _{DDIO} -0.2			V _{DDIO} -0.2		V
		I _{OH} = 6 mA	1.8	V _{DDIO} -0.45			V _{DDIO} -0.45		V
			3.6	V _{DDIO} -0.45			V _{DDIO} -0.45		V
V _{OL}	LOW Level Output Voltage	V _{IN} = V _{IL} , I _{OL} = -100 μA	1.8			0.2		0.2	V
			3.6			0.2		0.2	
			4.0			0.2		0.2	
		I _{OL} = -6 mA	1.8			0.45		0.45	
			3.6			0.5		0.5	
R _{PULL}	Pull-Up or Pull-Down Resistors				100			kΩ	
I _{OL}	Output Low Current		1.8 to 4.0	6.0			6.0	mA	
I _{OH}	Output High Current		1.8 to 4.0	-6.0			-6.0	mA	
I _{IN}	Input Low Current (Note 3)	0 ≤ V _{IN} ≤ V _{DDIO}	1.8 to 4.0			±50		±50	μA
I _{OFF}	Power-Off Leakage Current	V _{IN} = 4.0 V	0			1		10	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Includes all internal circuitry consumption from the V_{CC} supply. Does not include the I/O buffers, which are supplied by V_{DDIO} and are load dependent.
3. I_{IL} and I_{IH} specifications only apply when the outputs are configured with pull-down or pull-up resistors, respectively. Specifications values assume V_{IN} ≤ V_{DDIO}.

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Table 5. AC ELECTRICAL CHARACTERISTICS (All typical values are for $V_{CC} = 1.8\text{ V}$ at $T_A = 25^\circ\text{C}$ unless otherwise specified.)

Symbol	Parameter	Fast Mode		Unit
		Min	Max	
t_W	Reset Pulse Duration (see Figure 3)	150		ns
t_{RST_GLITCH}	Input Glitch Rejection on RST Pin (see Figure 3)	50	150	ns
t_{RESET}	Reset Time, Total Time from Rising Edge of Reset Pulse to Falling Edge of \overline{INT} Pin (see Figure 4)		150	ns
t_{IV}	Time from Input Default State Change to \overline{INT} Pin Driven LOW (see Figure 5)		4	μs

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

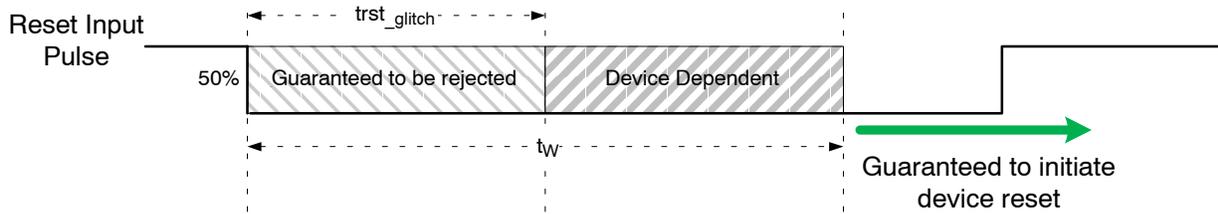


Figure 3. Reset Pulse Duration and Input Glitch Rejection Timing Diagram

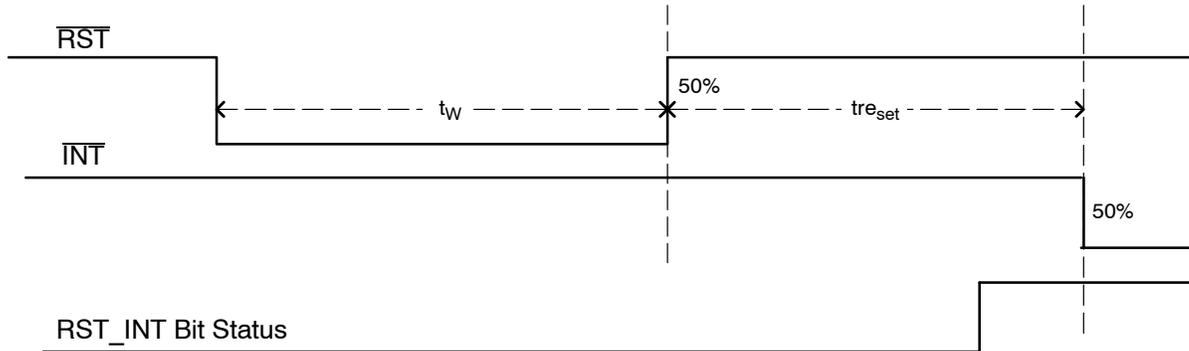


Figure 4. Reset Time and Reset Pulse Timing Diagram

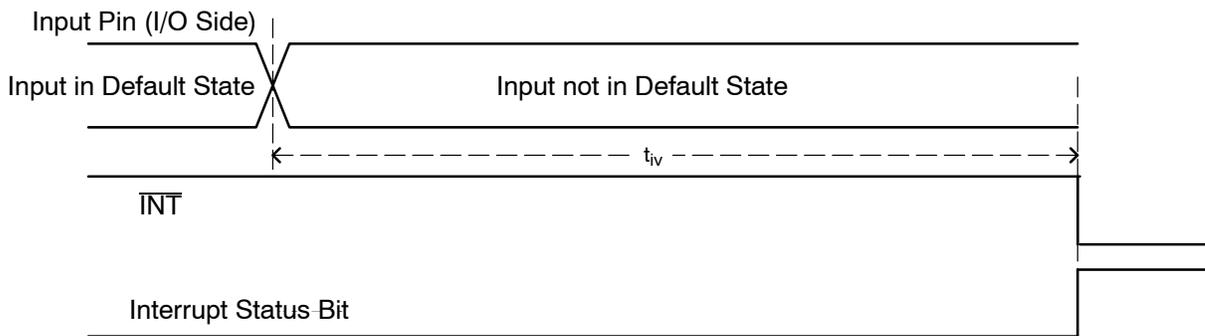


Figure 5. Time to INT from Change in Input Default State

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Table 6. DC CHARACTERISTICS (I²C CONTROLLER SDA, SCL)

Symbol	Parameter	Fast Mode (400 kHz)		
		Min	Max	Unit
V _{IL}	Low-Level Input Voltage	-0.5	0.3 V _{CC}	V
V _{IH}	High-Level Input Voltage	0.7 V _{CC}		V
V _{HYS}	Hysteresis of Schmitt Trigger Inputs	V _{CC} > 2 V	0.05 V _{CC}	V
		V _{CC} < 2 V	0.1 V _{CC}	
V _{OL}	Low-level Output Voltage at 3 mA Sink Current (Open-Drain or Open-Collector)	V _{CC} > 2 V	0	V
		V _{CC} < 2 V	0.2 V _{CC}	
I _I	Input Current of Each I/O Pin, Input Voltage 0.26 V to 2.34 V	-10	10	μA
C _I	Capacitance for Each I/O Pin		10	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Table 7. AC ELECTRICAL CHARACTERISTICS (All typical values are for V_{CC} = 1.8 V at T_A = 25°C unless otherwise specified.)

Symbol	Parameter	Fast Mode (400 kHz)		
		Min	Max	Unit
f _{SCL}	SCL Clock Frequency	0	400	kHz
t _{HD;STA}	Hold Time (Repeated) START Condition	0.6		μs
t _{LOW}	LOW Period of SCL Clock (Note 4)	1.3		μs
t _{HIGH}	HIGH Period of SCL Clock	0.6		μs
t _{SU;STA}	Set Up Time for Repeated START Condition	0.6		μs
t _{HD;DAT}	Data Hold Time (See Figure 6)	0	0.9	μs
t _{SU;DAT}	Data Set Up Time (See Figure 6) (Note 5)	100		ns
t _{PS}	Set Up Time Required by SDA Input Buffer (When Receiving Data)	0		ns
t _{PH}	Out Delay Required by SDA Output Buffer (When Transmitting Data)	300		ns
t _r	Rise Time of SDA and SCL Signals (Note 6, 7)	20 + 0.1C _b	300	ns
t _f	Fall Time of SDA and SCL Signals (Note 6, 7)	20 + 0.1C _b	300	ns
t _{SU;STOP}	Set Up Time for STOP Condition	0.6		μs
t _{BUF}	Bus Free Time between a STOP and START Conditions	1.3		μs
t _{SP}	Pulse Width of Spikes that Must Be Suppressed by the Input Filter	0	50	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. The FXL6408 can accept clock signals with LOW as low as 1.1 μs, provided that the received SDA signal t_{HD;DAT} + t_{r/f} ≤ 1.1 μs. The FXL6408 features a 0 ns SDA input setup time and, therefore, this parameter is not included in the above equation.
5. A Fast-Mode I²C-Bus[®] device can be used in a Standard-Mode I²C-Bus system, but the requirement t_{SU;DAT} ≥ 250 ns must be met. This is automatically the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal. It must output the next data bit to the SDA line t_{r,max} + t_{SU;DAT} = 1000 + 250 = 1250 ns (according to the Standard-Mode I²C bus specification) before the SCL line is released.
6. C_b equals the total capacitance of one bus line in pF. If mixed with High-Speed Mode devices, faster fall times are allowed, according to the I²C specification.
7. The FXL6408 ensures that the SDA signal out must coincide with SCL LOW for worst-case SCL t_f maximum times of 300 ns. This requirement prevents data loss by preventing SDA out transitions during the undefined region of the falling edge of SCL. Consequently, the FXL6408 fulfils the following requirement from the I²C specification, note 2 on page 77: "A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the V_{IH,min} of the SCL signal) to bridge the undefined region of the falling edge of SCL."
8. FXL6408 I²C slave is fully compliant the NXP (Phillips) I²C specification Rev. 0.3 UM10204 (2007).

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Translation

The FXL6408 has the ability to translate between the system I²C voltage reference and the I/O voltage reference. The V_{CC} pin is used both as the FXL6408 power supply as well as the voltage reference for the I²C inputs, ADDR, $\overline{\text{INT}}$ and RESET pins. The V_{DDIO} pin is used only for the voltage supply reference of the I/O ports. For example, a 1.8 V-referenced I²C Bus can be used to interface with the FXL6408 and control 3.6 V-referenced I/Os by supplying V_{CC} = 1.8 V and V_{DDIO} = 3.6 V. If translation

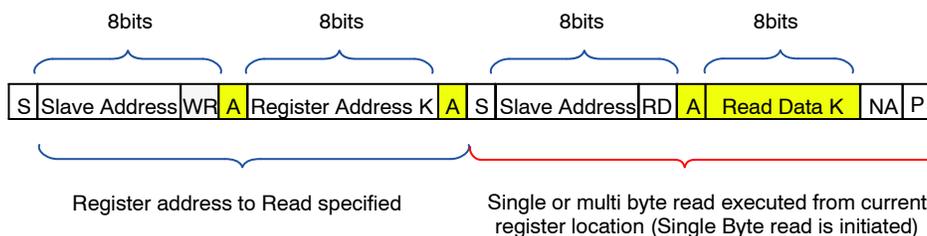
is not needed, the system provides the same voltage to both the V_{CC} and V_{DDIO} pins. If both the I/O and I²C interfaces are referenced to 1.8 V, the V_{CC} supply and V_{DDIO} pin should both be tied to 1.8 V.

I²C Read / Write Procedures

Figure 7 and Figure 8 illustrate compatible I²C write and read sequences. The FXL6408 does not support burst read or write optional modes described in the I²C standard.



Figure 7. I²C Write Sequence



NOTE: If Register is not specified the Master reads from the current register.

	From Master to Slave	S Start Condition	NA NOT Acknowledge (SDA high)	RD Read = 1
	From Slave to Master	A Acknowledge (SDA Low)	WR Write=0	P Stop Condition

Figure 8. I²C Read Sequence

Table 8. I²C ADDRESS

Name	ADDR Pin	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Device Address	ADDR = 0	1	0	0	0	0	1	1	WR
	ADDR = 1	1	0	0	0	1	0	0	WR

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Table 9. I²C REGISTER MAP

Register	Address	Type	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Reset Value
Device ID & Ctrl	01h	R/W	MF3	MF2	MF1	FW_rev3	FW_rev2	FW_rev1	RST_INT	SW_RST	10100010
IO Direction	03h	R/W	GPIO7	GPIO6	GPIO5	GPIO4	GPIO3	GPIO2	GPIO1	GPIO0	00000000
Output State	05h	R/W	Out 7	Out 6	Out 5	Out 4	Out 3	Out 2	Out 1	Out 0	00000000
Output High-Z	07h	R/W	Out 7	Out 6	Out 5	Out 4	Out 3	Out 2	Out 1	Out 0	11111111
Input Default State	09h	R/W	In 7	In 6	In 5	In 4	In 3	In 2	In 1	In 0	00000000
Pull Enable	0Bh	R/W	In 7	In 6	In 5	In 4	In 3	In 2	In 1	In 0	11111111
Pull-Down/ Pull-Up	0Dh	R/W	In 7	In 6	In 5	In 4	In 3	In 2	In 1	In 0	00000000
Input Status	0Fh	R	In 7	In 6	In 5	In 4	In 3	In 2	In 1	In 0	XXXXXXXX
Interrupt Mask	11h	R/W	In 7	In 6	In 5	In 4	In 3	In 2	In 1	In 0	00000000
Interrupt Status	13h	R/W	In 7	In 6	In 5	In 4	In 3	In 2	In 1	In 0	XXXXXXXX
Reserved	02h, 04h, 06h, 08h, 0Ah, 0Ch, 0Eh, 10h, 12h	Reserved	XXXXXXXX								

Table 10. DEVICE ID & CONTROL (Address 01_h; RST INT flag is cleared after being read by master; for SW reset, the master writes bit 0 HIGH)

Bit #	Name	Bit Size	Description
7:5	MF	3	3-bit manufacturer ID assigned by Nokia, Bits 7:5 are 101 for onsemi .
4:2	FW_rev	3	3-bit ascending value, indicating the firmware revision. Initial revision is 000.
1	RST_INT	1	Indicates that the device has been reset and the default values are set. 0: normal operation 1: the device has been reset and register default values are set
0	SW_RST	1	Software reset: 0: normal operation 1: SW reset commanded

Table 11. IO DIRECTION (Address 03_h)

Bit #	Name	Bit Size	Description
7	GPIO7	1	0: GPIO configured as Input 1: GPIO configured as Output
6	GPIO6	1	
5	GPIO5	1	
4	GPIO4	1	
3	GPIO3	1	
2	GPIO2	1	
1	GPIO1	1	
0	GPIO0	1	

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Table 12. OUTPUT STATE (Address 05_h; if the pin is defined as input in register 03_h, the corresponding bit has no effect)

Bit #	Name	Bit Size	Description
7	Out 7	1	0: GPIO Output = LOW 1: GPIO Output = HIGH
6	Out 6	1	
5	Out 5	1	
4	Out 4	1	
3	Out 3	1	
2	Out 2	1	
1	Out 1	1	
0	Out 0	1	

Table 13. OUTPUT HIGH-Z (Address 07_h; if the pin is defined as input in register 03_h, the corresponding bit has no effect)

Bit #	Name	Bit Size	Description
7	Out 7	1	0: GPIO Output state follows register 05 _h 1: GPIO Output = HIGH-Z
6	Out 6	1	
5	Out 5	1	
4	Out 4	1	
3	Out 3	1	
2	Out 2	1	
1	Out 1	1	
0	Out 0	1	

Table 14. INPUT DEFAULT STATE (Address 09_h; defines the expected state of the GPIO; if the pin is defined as output in register 03_h, the corresponding bit has no effect)

Bit #	Name	Bit Size	Description
7	In 7	1	0: GPIO input default is set to LOW; when the GPIO goes HIGH, an interrupt is triggered 1: GPIO input default is set to HIGH; when the GPIO goes LOW, an interrupt is triggered
6	In 6	1	
5	In 5	1	
4	In 4	1	
3	In 3	1	
2	In 2	1	
1	In 1	1	
0	In 0	1	

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Table 15. PULL ENABLE (Address 0B_n; pull enable for input pin; if the pin is defined as output in register 03_n, the corresponding bit has no effect)

Bit #	Name	Bit Size	Description
7	In 7	1	0: GPIO input Pull-up/Pull-down is not enabled 1: GPIO input Pull-up/Pull-down is enabled
6	In 6	1	
5	In 5	1	
4	In 4	1	
3	In 3	1	
2	In 2	1	
1	In 1	1	
0	In 0	1	

Table 16. PULL-DOWN / PULL-UP (Address 0D_n; if the pin is defined as output in register 03_n, the corresponding bit has no effect; if the corresponding bit in register 0B_n=0, this register setting has no effect)

Bit #	Name	Bit Size	Description
7	In 7	1	0: GPIO input Pull-down is enabled 1: GPIO input Pull-up is enabled
6	In 6	1	
5	In 5	1	
4	In 4	1	
3	In 3	1	
2	In 2	1	
1	In 1	1	
0	In 0	1	

Table 17. INPUT STATUS (Address 0F_n; if the pin is defined as output in register 03_n, the corresponding bit has no effect; this bit shows the real-time input pin status)

Bit #	Name	Bit Size	Description
7	In 7	1	0: GPIO input is LOW 1: GPIO input is HIGH
6	In 6	1	
5	In 5	1	
4	In 4	1	
3	In 3	1	
2	In 2	1	
1	In 1	1	
0	In 0	1	

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Table 18. INTERRUPT MASK (Address 11_h; if the pin is defined as output in register 03_h, the corresponding bit has no effect; this bit enables the interrupt generation from input pin state change to INT)

Bit #	Name	Bit Size	Description
7	In 7	1	0: GPIO input interrupt is generated 1: GPIO input interrupt is masked
6	In 6	1	
5	In 5	1	
4	In 4	1	
3	In 3	1	
2	In 2	1	
1	In 1	1	
0	In 0	1	

Table 19. INTERRUPT STATUS (Address 13_h; this bit is HIGH if input GPIO ≠ default state (register 09_h); the flag is cleared after being read by the master (bit returns to 0); the input must go back to default state and change again before this flag is raised again)

Bit #	Name	Bit Size	Description
7	In 7	1	0: GPIO input is in default state or the flag has been cleared 1: GPIO input has changed state from default
6	In 6	1	
5	In 5	1	
4	In 4	1	
3	In 3	1	
2	In 2	1	
1	In 1	1	
0	In 0	1	

ORDERING INFORMATION

Table 20. ORDERING INFORMATION

Part Number	Top Mark	Operating Temperature Range	Package	Packing Method [†]
FXL6408UMX	XT	-40 to 85°C	16-Lead Ultra-thin Molded Leadless Package, Quad, 1.8 x 2.6 mm , 0.4P	5000 / Tape & Reel

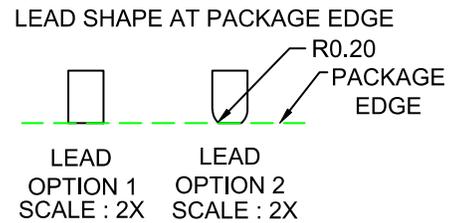
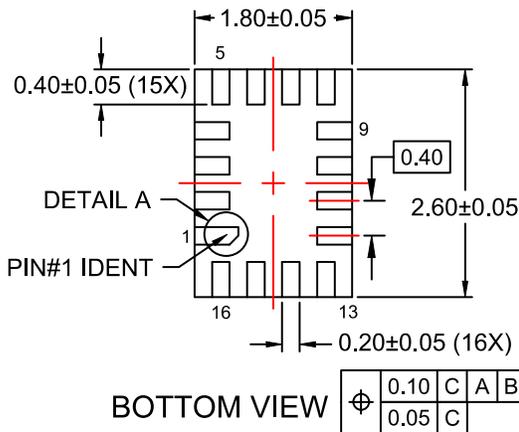
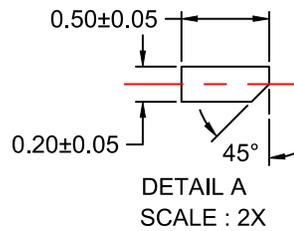
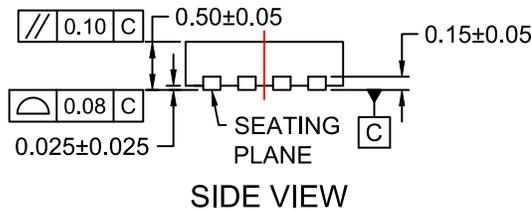
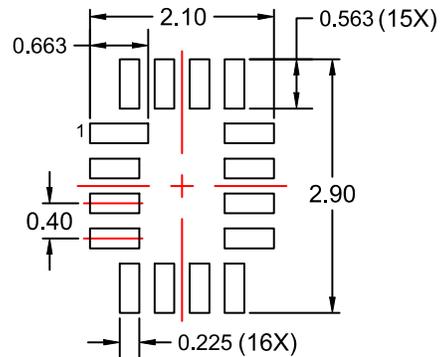
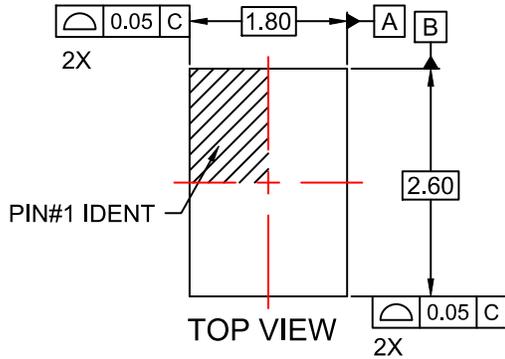
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

UQFN16 1.8x2.6, 0.4P
CASE 523BF
ISSUE O

DATE 31 OCT 2016



NOTES:

- A. PACKAGE DOES NOT FULLY CONFORM TO JEDEC STANDARD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. TERMINAL SHAPE MAY VARY ACCORDING TO PACKAGE SUPPLIER, SEE TERMINAL SHAPE VARIANTS.